Dual NPN Bias Resistor Transistors R1 = 4.7 k Ω , R2 = 4.7 k Ω

NPN Transistors with Monolithic Bias Resistor Network

This series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor (BRT) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base-emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space.

Features

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

(T_A = 25°C, common for Q_1 and $Q_2,$ unless otherwise noted)

Rating	Symbol	Max	Unit
Collector-Base Voltage	V _{CBO}	50	Vdc
Collector-Emitter Voltage	V _{CEO}	50	Vdc
Collector Current – Continuous	Ι _C	100	mAdc
Input Forward Voltage	V _{IN(fwd)}	30	Vdc
Input Reverse Voltage	V _{IN(rev)}	10	Vdc

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ORDERING INFORMATION

Device	Package	Shipping [†]
MUN5232DW1T1G, SMUN5232DW1T1G	SOT-363	3,000/Tape & Reel
NSBC143EDXV6T1G	SOT-563	4,000/Tape & Reel
NSBC143EDP6T5G	SOT-963	8,000/Tape & Reel

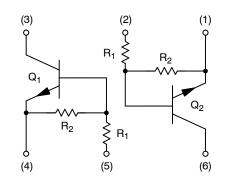
⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



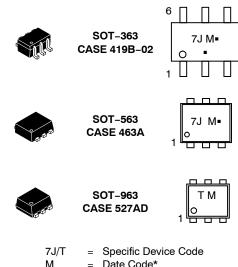
ON Semiconductor®

www.onsemi.com

PIN CONNECTIONS



MARKING DIAGRAMS



M = Date Code* = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

THERMAL CHARACTERISTICS

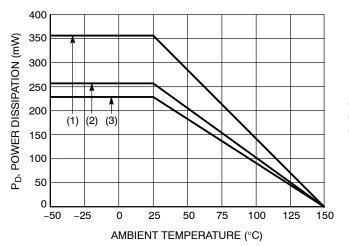
Characteristic	Symbol	Max	Unit
MUN5232DW1 (SOT-363) ONE JUNCTION HEATED			
Total Device Dissipation T _A = 25°C (Note 37) (Note 38) Derate above 25°C (Note 37) (Note 38)	PD	187 256 1.5 2.0	mW mW/°C
Thermal Resistance,(Note 37)Junction to Ambient(Note 38)	R _{θJA}	670 490	°C/W
MUN5232DW1 (SOT-363) BOTH JUNCTION HEATED (Note 39)		·	
Total Device Dissipation T _A = 25°C (Note 37) (Note 38) Derate above 25°C (Note 37) (Note 38)	PD	250 385 2.0 3.0	mW mW/°C
Thermal Resistance, Junction to Ambient (Note 37) (Note 38)	R _{θJA}	493 325	°C/W
Thermal Resistance, Junction to Lead (Note 37) (Note 38)	R _{θJL}	188 208	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C
NSBC143EDXV6 (SOT-563) ONE JUNCTION HEATED			
Total Device Dissipation T _A = 25°C (Note 37) Derate above 25°C (Note 37)	PD	357 2.9	mW mW/°C
Thermal Resistance, Junction to Ambient (Note 37)	$R_{ hetaJA}$	350	°C/W
NSBC143EDXV6 (SOT-563) BOTH JUNCTION HEATED (Note 3	39)		
Total Device Dissipation T _A = 25°C (Note 37) Derate above 25°C (Note 37)	PD	500 4.0	mW mW/°C
Thermal Resistance, Junction to Ambient (Note 37)	R _{θJA}	250	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C
NSBC143EDP6 (SOT-963) ONE JUNCTION HEATED			
Total Device Dissipation T _A = 25°C (Note 40) (Note 41) Derate above 25°C (Note 40) (Note 41)	PD	231 269 1.9 2.2	MW mW/°C
Thermal Resistance, Junction to Ambient (Note 40) (Note 41)	R _{θJA}	540 464	°C/W
NSBC143EDP6 (SOT-963) BOTH JUNCTION HEATED (Note 39))	· · ·	
Total Device Dissipation $T_A = 25^{\circ}C$ (Note 40) (Note 41) Derate above 25^{\circ}C (Note 40) (Note 41)	PD	339 408 2.7 3.3	MW mW/°C
Thermal Resistance, Junction to Ambient (Note 40) (Note 41)	R _{0JA}	369 306	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

38. FR-4 @ 1.0 × 1.0 Inch Pad.
39. Both junction heated values assume total power is sum of two equally powered channels.
40. FR-4 @ 100 mm², 1 oz. copper traces, still air.
41. FR-4 @ 500 mm², 1 oz. copper traces, still air.

Characteristic	Symbol	Min	Тур	Мах	Unit
OFF CHARACTERISTICS					
Collector-Base Cutoff Current $(V_{CB} = 50 \text{ V}, I_E = 0)$	I _{CBO}	-	-	100	nAdc
Collector-Emitter Cutoff Current $(V_{CE} = 50 \text{ V}, I_B = 0)$	I _{CEO}	_	-	500	nAdc
Emitter-Base Cutoff Current $(V_{EB} = 6.0 \text{ V}, I_C = 0)$	I _{EBO}	-	-	1.5	mAdc
Collector-Base Breakdown Voltage $(I_C = 10 \ \mu A, I_E = 0)$	V _(BR) CBO	50	-	-	Vdc
Collector-Emitter Breakdown Voltage (Note 42) $(I_C = 2.0 \text{ mA}, I_B = 0)$	V _{(BR)CEO}	50	-	_	Vdc
ON CHARACTERISTICS					
DC Current Gain (Note 42) (I _C = 5.0 mA, V _{CE} = 10 V)	h _{FE}	15	30	-	
Collector-Emitter Saturation Voltage (Note 42) $(I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA})$	V _{CE(sat)}	-	-	0.25	V
Input Voltage (Off) $(V_{CE} = 5.0 \text{ V}, I_C = 100 \ \mu\text{A})$	V _{i(off)}	-	1.2	-	Vdc
Input Voltage (On) $(V_{CE} = 0.2 \text{ V}, I_C = 20 \text{ mA})$	V _{i(on)}	_	2.4	-	Vdc
Output Voltage (On) (V_{CC} = 5.0 V, V_B = 2.5 V, R_L = 1.0 k Ω)	V _{OL}	-	-	0.2	Vdc
Output Voltage (Off) $(V_{CC} = 5.0 \text{ V}, \text{ V}_{B} = 0.25 \text{ V}, \text{ R}_{L} = 1.0 \text{ k}\Omega)$	V _{OH}	4.9	-	_	Vdc
Input Resistor	R1	3.3	4.7	6.1	kΩ
Resistor Ratio	R ₁ /R ₂	0.8	1.0	1.2	

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$, common for Q_1 and Q_2 , unless otherwise noted)

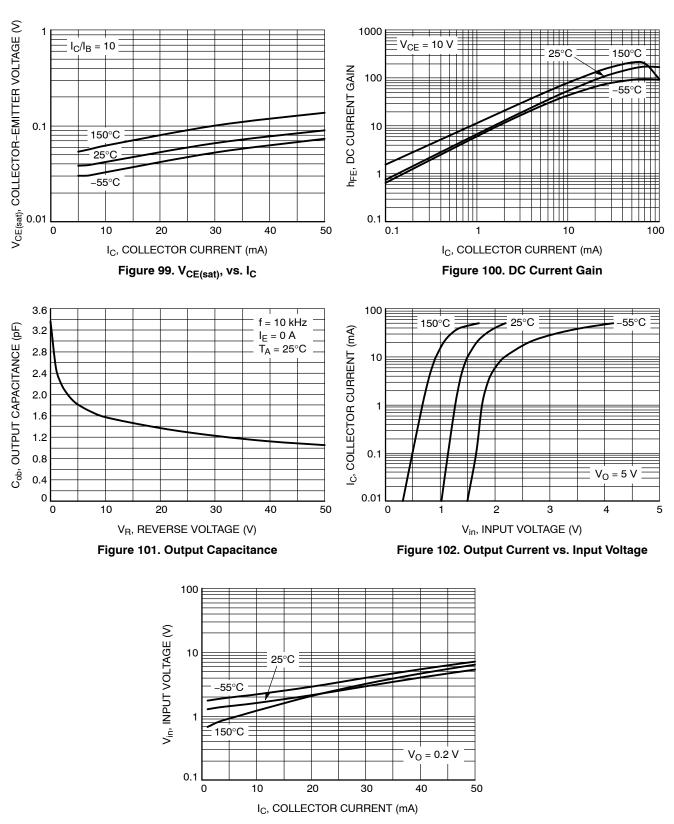
42. Pulsed Condition: Pulse Width = 300 ms, Duty Cycle \leq 2%.



(1) SOT–363; 1.0 × 1.0 Inch Pad (2) SOT–563; Minimum Pad

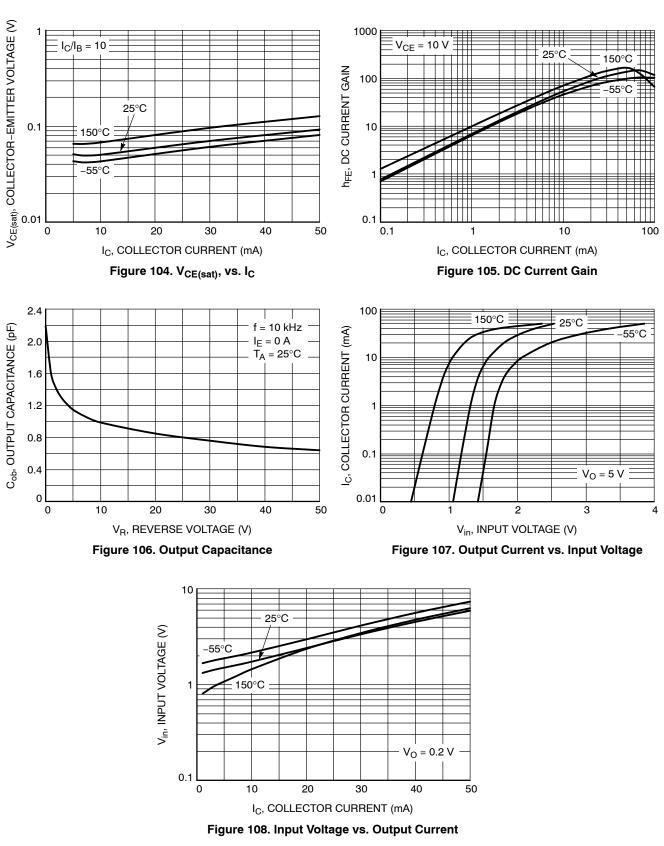
(3) SOT-963; 100 mm², 1 oz. Copper Trace

Figure 98. Derating Curve



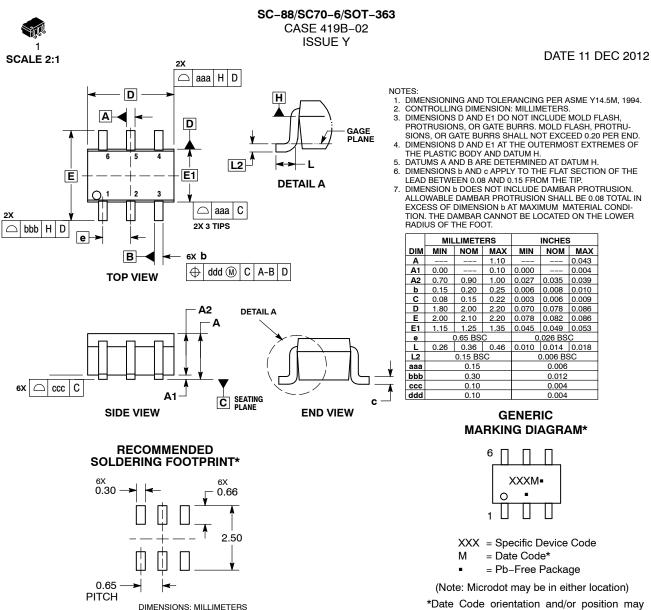
TYPICAL CHARACTERISTICS MUN5232DW1, NSBC143EDXV6

Figure 103. Input Voltage vs. Output Current



TYPICAL CHARACTERISTICS NSBC143EDP6





- *Date Code orientation and/or position may vary depending upon manufacturing location.
 - *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

STYLES ON PAGE 2

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*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and

Mounting Techniques Reference Manual, SOLDERRM/D.

SC-88/SC70-6/SOT-363 CASE 419B-02 ISSUE Y

DATE 11 DEC 2012

STYLE 1: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 2: CANCELLED	STYLE 3: CANCELLED	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. COLLECTOR 4. EMITTER 5. BASE 6. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. COLLECTOR 4. EMITTER 5. BASE 6. CATHODE	STYLE 6: PIN 1. ANODE 2 2. N/C 3. CATHODE 1 4. ANODE 1 5. N/C 6. CATHODE 2
STYLE 7: PIN 1. SOURCE 2 2. DRAIN 2 3. GATE 1 4. SOURCE 1 5. DRAIN 1 6. GATE 2	STYLE 8: CANCELLED	STYLE 9: PIN 1. EMITTER 2 2. EMITTER 1 3. COLLECTOR 1 4. BASE 1 5. BASE 2 6. COLLECTOR 2	STYLE 10: PIN 1. SOURCE 2 2. SOURCE 1 3. GATE 1 4. DRAIN 1 5. DRAIN 2 6. GATE 2	STYLE 11: PIN 1. CATHODE 2 2. CATHODE 2 3. ANODE 1 4. CATHODE 1 5. CATHODE 1 6. ANODE 2	STYLE 12: PIN 1. ANODE 2 2. ANODE 2 3. CATHODE 1 4. ANODE 1 5. ANODE 1 6. CATHODE 2
STYLE 13:	STYLE 14:	STYLE 15:	STYLE 16:	STYLE 17:	STYLE 18:
PIN 1. ANODE	PIN 1. VREF	PIN 1. ANODE 1	PIN 1. BASE 1	PIN 1. BASE 1	PIN 1. VIN1
2. N/C	2. GND	2. ANODE 2	2. EMITTER 2	2. EMITTER 1	2. VCC
3. COLLECTOR	3. GND	3. ANODE 3	3. COLLECTOR 2	3. COLLECTOR 2	3. VOUT2
4. EMITTER	4. IOUT	4. CATHODE 3	4. BASE 2	4. BASE 2	4. VIN2
5. BASE	5. VEN	5. CATHODE 2	5. EMITTER 1	5. EMITTER 2	5. GND
6. CATHODE	6. VCC	6. CATHODE 1	6. COLLECTOR 1	6. COLLECTOR 1	6. VOUT1
STYLE 19:	STYLE 20:	STYLE 21:	STYLE 22:	STYLE 23:	STYLE 24:
PIN 1. I OUT	PIN 1. COLLECTOR	PIN 1. ANODE 1	PIN 1. D1 (i)	PIN 1. Vn	PIN 1. CATHODE
2. GND	2. COLLECTOR	2. N/C	2. GND	2. CH1	2. ANODE
3. GND	3. BASE	3. ANODE 2	3. D2 (i)	3. Vp	3. CATHODE
4. V CC	4. EMITTER	4. CATHODE 2	4. D2 (c)	4. N/C	4. CATHODE
5. V EN	5. COLLECTOR	5. N/C	5. VBUS	5. CH2	5. CATHODE
6. V REF	6. COLLECTOR	6. CATHODE 1	6. D1 (c)	6. N/C	6. CATHODE
STYLE 25:	STYLE 26:	STYLE 27:	STYLE 28:	STYLE 29:	STYLE 30:
PIN 1. BASE 1	PIN 1. SOURCE 1	PIN 1. BASE 2	PIN 1. DRAIN	PIN 1. ANODE	PIN 1. SOURCE 1
2. CATHODE	2. GATE 1	2. BASE 1	2. DRAIN	2. ANODE	2. DRAIN 2
3. COLLECTOR 2	3. DRAIN 2	3. COLLECTOR 1	3. GATE	3. COLLECTOR	3. DRAIN 2
4. BASE 2	4. SOURCE 2	4. EMITTER 1	4. SOURCE	4. EMITTER	4. SOURCE 2
5. EMITTER	5. GATE 2	5. EMITTER 2	5. DRAIN	5. BASE/ANODE	5. GATE 1
6. COLLECTOR 1	6. DRAIN 1	6. COLLECTOR 2	6. DRAIN	6. CATHODE	6. DRAIN 1

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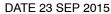
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SOT-563, 6 LEAD CASE 463A

ISSUE G



D -X-5 4 Ē H_{F} 01 2 3 > b 6 PL С е \oplus 0.08 (0.003) 🔘 X Y

STYLE 1:	STYLE 2:
PIN 1. EMITTER 1	PIN 1. EMITTER 1
2. BASE 1	2. EMITTER2
3. COLLECTOR 2	3. BASE 2
4. EMITTER 2	4. COLLECTOR 2
5. BASE 2	5. BASE 1
6. COLLECTOR 1	6. COLLECTOR 1
STYLE 4:	STYLE 5:
PIN 1. COLLECTOR	PIN 1. CATHODE
2. COLLECTOR	2. CATHODE
3. BASE	3. ANODE
4. EMITTER	4. ANODE
5. COLLECTOR	5. CATHODE
6. COLLECTOR	6. CATHODE
STYLE 7:	STYLE 8:

PIN 1. DRAIN 2. DRAIN 3. GATE 4. SOURCE 5. DRAIN 6. DRAIN

PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. ANODE 6. CATHODE

- STYLE 10: PIN 1. CATHODE 1 2. N/C 3. CATHODE 2 4. ANODE 2 5. N/C

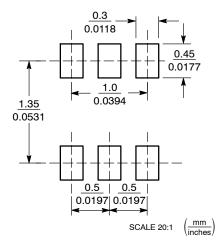
 - 6. ANODE 1

STYLE 3: PIN 1. CATHODE 1 2. CATHODE 1 3. ANODE/ANODE 2 4. CATHODE 2 5. CATHODE 2 6. ANODE/ANODE 1 STYLE 6: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE

5. CATHODE 6. CATHODE STYLE 9 PIN

	9.
N 1.	SOURCE 1
2.	GATE 1
З.	DRAIN 2
4.	SOURCE 2
5.	GATE 2
6.	DRAIN 1

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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NOTES

2.

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: MILLIMETERS

MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS З. IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MILLIMETERS				INCHES	;
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.50	0.55	0.60	0.020	0.021	0.023
b	0.17	0.22	0.27	0.007	0.009	0.011
С	0.08	0.12	0.18	0.003	0.005	0.007
D	1.50	1.60	1.70	0.059	0.062	0.066
E	1.10	1.20	1.30	0.043	0.047	0.051
е		0.5 BSC)	0	0.02 BSC)
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	1.50	1.60	1.70	0.059	0.062	0.066

GENERIC **MARKING DIAGRAM***

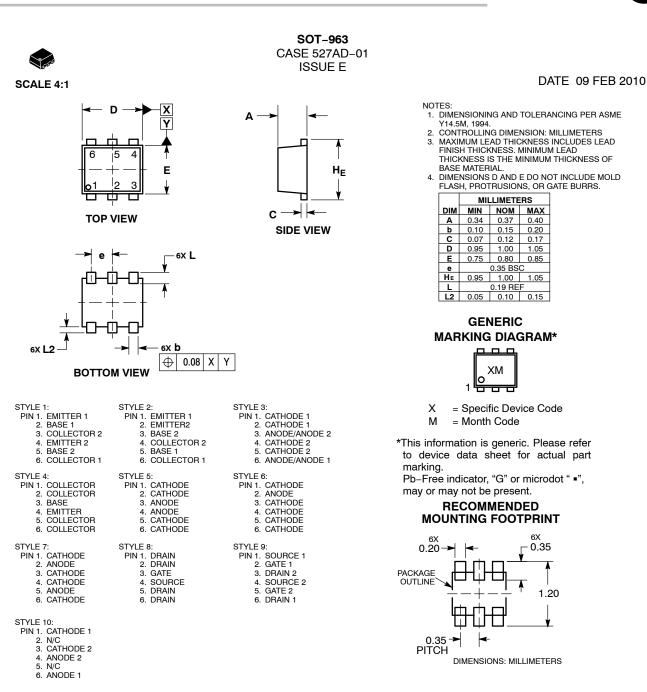


XX = Specific Device Code

- M = Month Code
- = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present.





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